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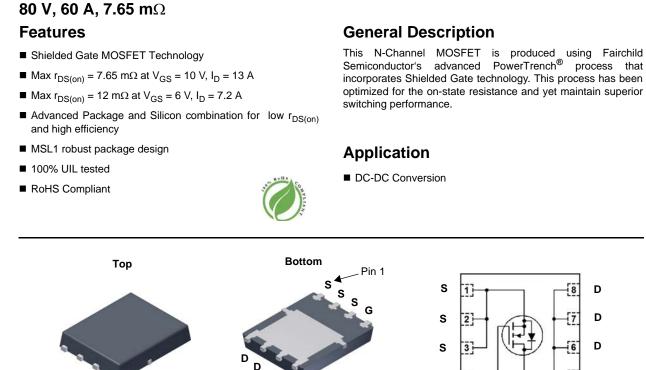


# **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET



Power 56

Symbol	Parameter			Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			80	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		60	
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	13	Α
	-Pulsed			200	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	135	mJ
D	Power Dissipation	T <sub>C</sub> = 25 °C		104	w
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C
Thermal Ch	naracteristics				
R <sub>θJC</sub>	Thermal Resistance, Junction to Case			1.2	

G

$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86322	FDMS86322	Power 56	13 "	12 mm	3000 units

FAIRCHILD

**FDMS86322** 



October 2014

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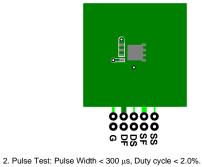
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	80			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		66		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			800	nA	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	acteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.9	4.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-9		mV/°C	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13 A		6.1	7.65	mΩ	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 7.2 A		8.2	12		
. ,		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13 A, T <sub>J</sub> = 125 °C		10.7	14	-	
		$V_{GS} = 10 V, 10 = 10 A, 11 = 120 O$		10.1			
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$		45		S	
Dynamic	Characteristics			45		1	
Dynamic C <sub>iss</sub>	Characteristics	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 13 A		45 2255	3000	pF	
<b>Dynamic</b> C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance			45 2255 460	3000 610	pF pF	
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000	pF pF pF	
<b>Dynamic</b> C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460	3000 610	pF pF	
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000 610	pF pF pF	
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		45 2255 460 30	3000 610	pF pF pF	
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ - f = 1 MHz - $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$		45 2255 460 30 1.0	3000 610 45	pF pF pF Ω	
Dynamic C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1  MHz		45 2255 460 30 1.0 15	3000 610 45 27	pF pF pF Ω ns	
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ Switching $t_{d(on)}$ $t_r$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ - $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ - f = 1 MHz - $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$		45 2255 460 30 1.0 15 11	3000 610 45 27 20	pF pF pF Ω ns	
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		45 2255 460 30 1.0 15 11 27	3000 610 45 27 20 44	pF pF Ω ns ns	
Dynamic $C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Characteristics         Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V},$ $V_{DD} = 50 \text{ V},$		45 2255 460 30 1.0 15 11 27 7	3000 610 45 27 20 44 13	pF pF Ω ns ns ns ns	
Dynamic $C_{iss}$ $C_{css}$ $C_{rss}$ $R_g$ Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance  Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$ $V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		45 2255 460 30 1.0 15 11 27 7 39	3000 610 45 27 20 44 13 55	pF pF Ω ns ns ns ns nc	

V	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.7	1.2	V
V <sub>SD</sub>	Source to Drain Didde Porward Voltage	$V_{GS} = 0 V, I_S = 13 A$ (Note 2)	0.8	1.3	v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>E</sub> = 13 A, di/dt = 100 A/μs	56	90	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 15 \text{ A}, \text{ u/ut} = 100 \text{ A/} \mu \text{s}$	61	98	nC

Notes:

1. R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

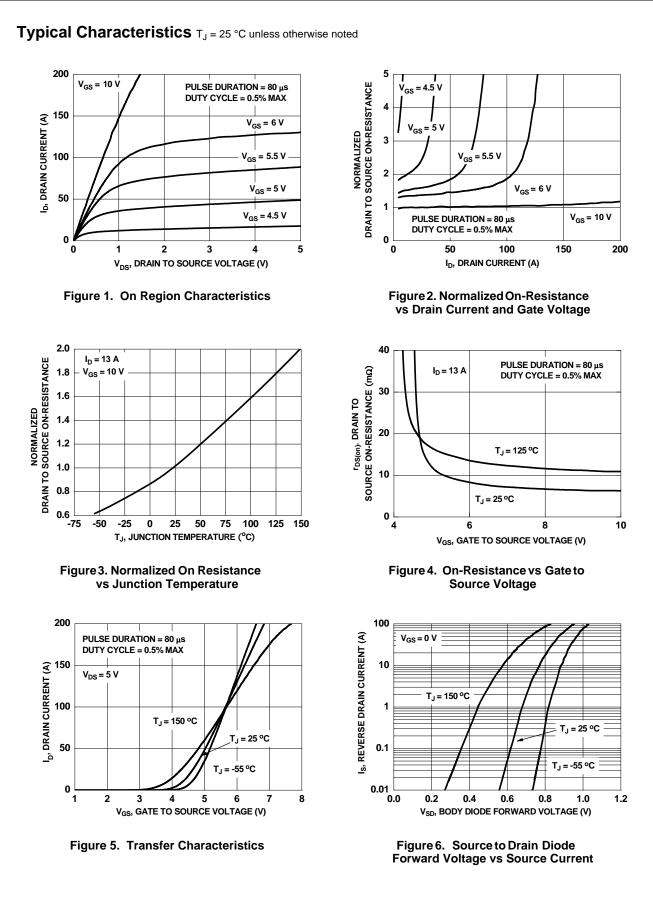


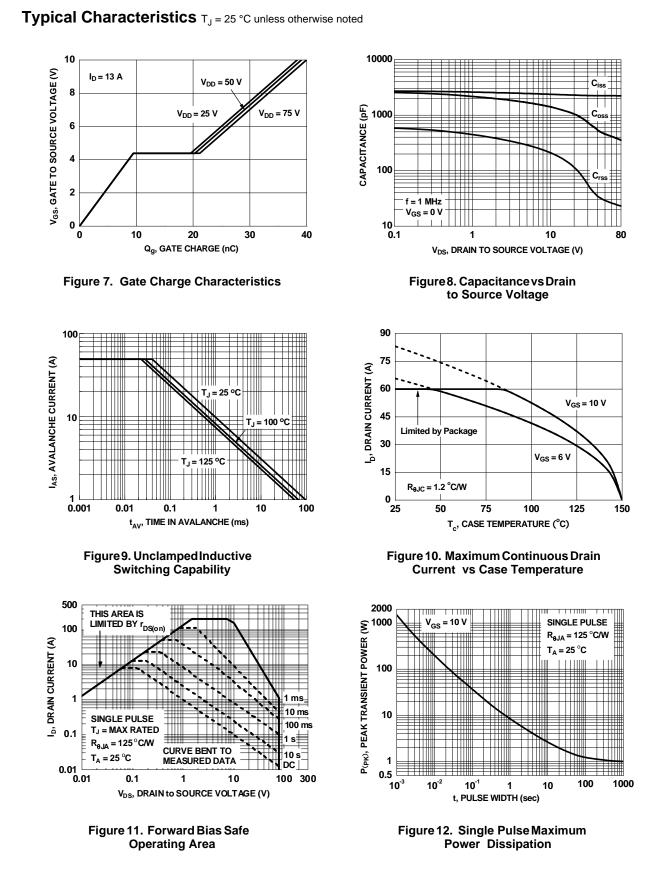
3. Starting  $T_J$  = 25 °C, L = 0.3 mH,  $I_{AS}$  = 30 A,  $V_{DD}$  = 75 V,  $V_{GS}$  = 10 V

a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

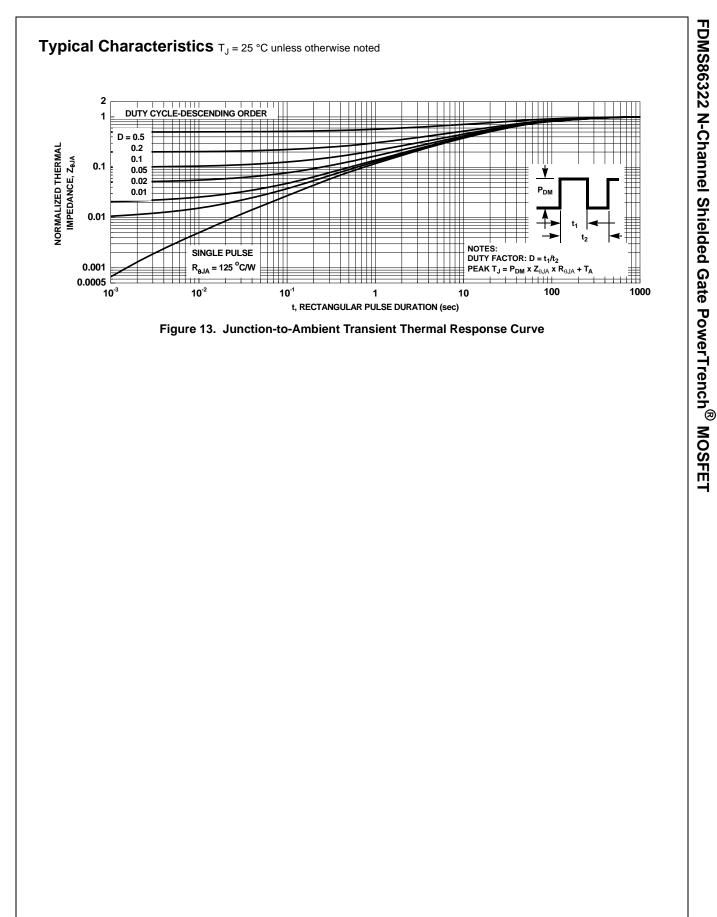


b. 125 °C/W when mounted on a minimum pad of 2 oz copper.





FDMS86322 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET





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